

NOA1305

Ambient Light Sensor with I²C Interface and Dark Current Compensation

Description

The NOA1305 ambient light sensor (ALS) is designed for handheld applications and integrates a 16-bit ADC, a 2-wire I²C digital interface, internal clock oscillator and a power down mode. The built in dynamic dark current compensation and precision calibration capability coupled with excellent IR and 50/60 Hz flicker rejection enables highly accurate measurements from very low light levels to full sunlight. The device can support simple count equals lux readings in interrupt-driven or polling modes. The NOA1305 employs proprietary CMOS image sensing technology from ON Semiconductor to provide large signal to noise ratio (SNR) and wide dynamic range (DR) over the entire operating temperature range. The optical filter used with this chip provides a light response similar to that of the human eye.

Features

- Senses Ambient Light and Provides an Output Count Proportional to the Ambient Light Intensity
- Photopic Spectral Response
- Dynamic Dark Current Compensation
- IR Rejection Eliminates Need for Additional IR Photodiode
- Less than 120 μ A Active Power Consumption in Normal Operation
- Less than 2 μ A Power Dissipation in Power Down Mode
- Interrupt Signal Notifies Host of Significant Intensity Changes
- Wide Operating Voltage Range (2.4 V to 3.6 V)
- Wide Operating Temperature Range (-40°C to 85°C)
- Linear Response Over the Full Operating Range
- Senses Intensity of Ambient Light from 0.165 Lux to Over 100K Lux
- 8 Selectable Integration Times Ranging from 6.25 ms to 800 ms
- No External Components Required
- Built-in 16-bit ADC
- I²C Serial Communication Port Supports Standard and Fast Modes
- Metal Mask Programmable I²C Slave Address Option Available
- These Devices are Pb-Free and are RoHS Compliant

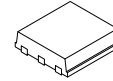
Applications

- Saves Display Power In Applications Such As:
 - ◆ Cell Phones, PDAs, MP3 Players, GPS
 - ◆ Cameras, Video Recorders
 - ◆ Mobile Devices with Displays or Backlit Keypads



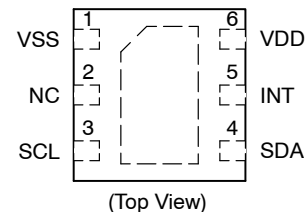
ON Semiconductor®

<http://onsemi.com>



CUDFN6
CU SUFFIX
CASE 505AD

PIN ASSIGNMENT



ORDERING INFORMATION

Device	Package	Shipping†
NOA1305CUTAG	CUDFN6 (Pb-Free)	2500 / Tape & Reel
Temperature Range		
-40°C to 85°C		

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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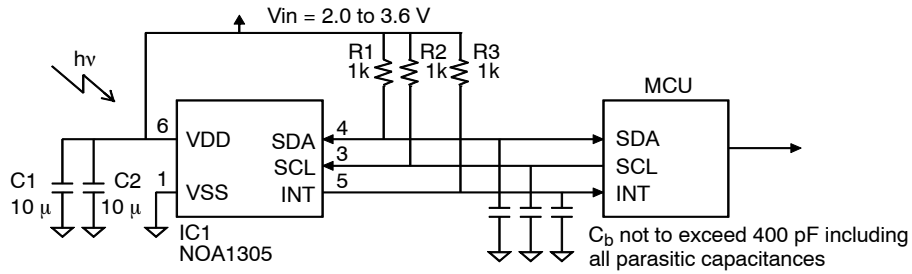


Figure 1. Typical Application Circuit

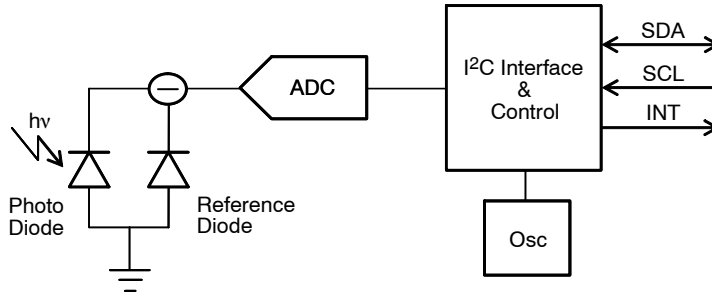


Figure 2. Simplified Block Diagram

Table 1. PIN FUNCTION DESCRIPTION

Pin	Pin Name	Description
1	VSS	Ground pin.
2	NC	No connection.
3	SCL	External I ² C clock supplied by the I ² C master. Requires a 1 kΩ pull-up resistor.
4	SDA	Bi-directional data signal for communications between this device and the I ² C master. Requires a 1 kΩ pull-up resistor.
5	INT	Interrupt request to the host. Programmable active state, open-drain output and requires an external 1 kΩ pull-up resistor.
6	VDD	Power pin.

Table 2. ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Input power supply	VDD	4.0	V
Input voltage range	V _{in}	-0.3 to VDD + 0.2	V
Output voltage range	V _{out}	-0.3 to VDD + 0.2	V
Maximum Junction Temperature	T _{J(max)}	85	°C
Storage Temperature	T _{STG}	-40 to 85	°C
ESD Capability, Human Body Model (Note 1)	ESD _{HBM}	2	kV
ESD Capability, Charged Device Model (Note 1)	ESD _{CDM}	750 (corner pins), 500 (center pins)	V
ESD Capability, Machine Model (Note 1)	ESD _{MM}	200	V
Moisture Sensitivity Level	MSL	5	-
Lead Temperature Soldering (Note 2)	T _{SLD}	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. This device incorporates ESD protection and is tested by the following methods:

ESD Human Body Model tested per EIA/JESD22-A114

ESD Charged Device Model tested per ESD-STM5.3.1-1999

ESD Machine Model tested per EIA/JESD22-A115

Latchup Current Maximum Rating: ≤ 100 mA per JEDEC standard: JESD78

2. For information, please refer to our Soldering and Mounting Techniques Reference Manual, SOLDERRM/D

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Table 3. OPERATING RANGES

Rating	Symbol	Standard Mode		Fast Mode		Unit
		Min	Max	Min	Max	
Power supply voltage	VDD	2.4	3.6	2.4	3.6	V
Power supply current	I _{DD}		120		120	μA
Quiescent supply current (Note 3)	I _{DD_ql}		2.0		2.0	μA
Low level input voltage (VDD related input levels)	V _{IL}	-0.5	0.3 VDD	-0.5	0.3 VDD	V
High level input voltage (VDD related input levels) (Note 4)	V _{IH}	0.7 VDD	VDD + 0.5	0.7 VDD	VDD + 0.5	V
Hysteresis of Schmitt trigger inputs (VDD > 2 V)	V _{hys}	N/A	N/A	0.05 VDD	-	V
Low level output voltage (open drain) at 3 mA sink current (VDD > 2 V)	V _{OL}	0	0.4	0	0.4	V
Output low current (V _{OL} =0.4 V)	I _{OL}	3	N/A	3	N/A	mA
Output low current (V _{OL} =0.6 V)	I _{OL}	N/A	N/A	6	N/A	mA
Output fall time from V _{IHmin} to V _{ILmax} with a bus capacitance, C _b from 10 pF to 400 pF (Note 4)	t _{of}	-	250	20+0.1C _b	250	ns
Pulse width of spikes which must be suppressed by the input filter	t _{SP}	N/A	N/A	0	50	ns
Input current of IO pin with an input voltage between 0.1 VDD and 0.9 VDD	I _i	-10	10	-10	10	μA
Capacitance on IO pin	C _l	-	10	-	10	pF
Operating free-air temperature range	T _A	-40	85	-40	85	°C

3. Current dissipation when a software Power Down command is sent to the device.

4. C_b = capacitance of one bus line, maximum value of which including all parasitic capacitances should be less than 400 pF.

Table 4. ELECTRICAL CHARACTERISTICS

(Unless otherwise specified, these specifications apply over VDD = 3.3 V, -40°C < T_A < 85°C) (Note 5)

Parameter	Symbol	Standard Mode		Fast Mode		Unit
		Min	Max	Min	Max	
SCL clock frequency	f _{SCL}	0	100	0	400	kHz
Hold time for START condition. After this period, the first clock pulse is generated.	t _{HD;STA}	4.0	-	0.6	-	μS
Low period of SCL clock	t _{LOW}	4.7		1.3		μS
High period of SCL clock	t _{HIGH}	4.0		0.6		μS
Set-up time for a repeated START condition	t _{SU;STA}	4.7	-	0.6	-	μS
Data hold time for I ² C-bus devices	t _{HD;DAT_d}	0	3.45	0	0.9	μS
Data set-up time	t _{SU;DAT}	250	-	100	-	nS
Rise time of both SDA and SCL (Note 6)	t _r	-	1000	20 + 0.1C _b	300	nS
Fall time of both SDA and SCL (Note 6)	t _f	-	300	20 + 0.1C _b	300	nS
Set-up time for STOP condition	t _{SU;STO}	4.0	-	0.6	-	μS
Bus free time between STOP and START condition	t _{BUF}	4.7	-	1.3	-	μS
Capacitive load for each bus line	C _b	-	400	-	400	pF
Noise margin at the low level for each connected device (including hysteresis)	V _{nL}	0.1 VDD	-	0.1 VDD	-	V
Noise margin at the high level for each connected device (including hysteresis)	V _{nH}	0.2 VDD	-	0.2 VDD	-	V
Parameter	Symbol	Typ		Typ		Unit
Internal Oscillator Frequency	f _{osc}	1		1		MHz

5. Refer to Figure 3 for more information on AC characteristics

6. The rise time and fall time are measured with a pull-up resistor R_p = 1 kΩ and C_b of 400 pF (including all parasitic capacitances).

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Table 5. OPTICAL CHARACTERISTICS

(Unless otherwise specified, these specifications are for VDD = 3.3 V, T_A = 25°C, T_{INT} = 200 ms)

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
Irradiance responsivity	λ_p (see Figure 5)	R _e		545		nM
Illuminance responsivity	White LED Source: Ev = 100 lux (see Figure 6)	R _{vi100}		154		Counts
	White LED source: Ev = 1000 lux (see Figure 6)	R _{vi1000}		1543		
Dark responsivity	Ev = 0 lux (see Figure 6)	I _{DARK}		0		Counts

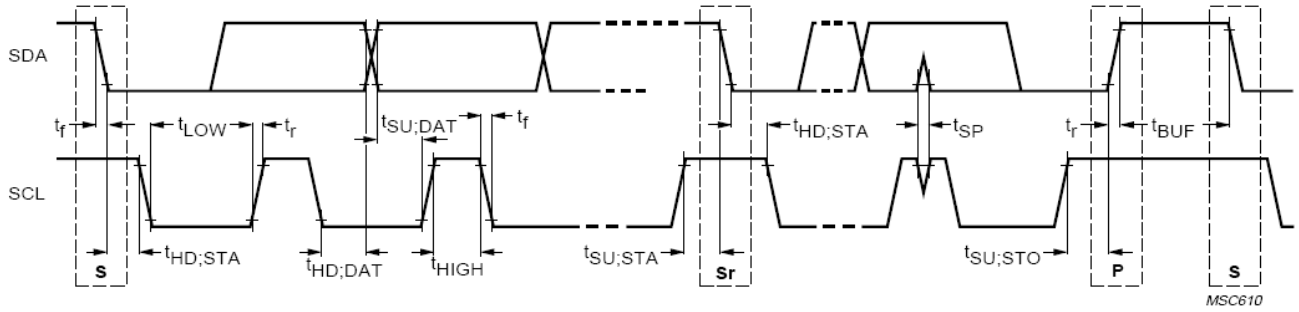


Figure 3. AC Characteristics

TYPICAL CHARACTERISTICS

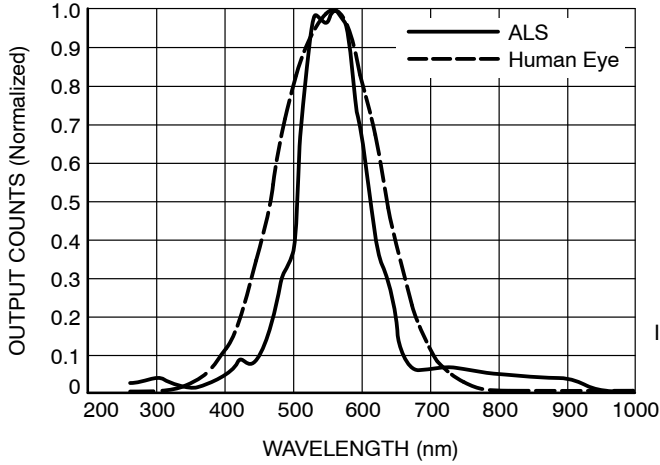


Figure 4. Spectral Response

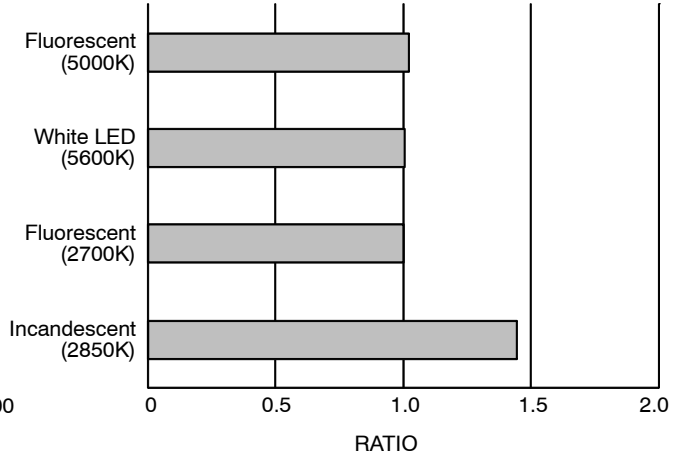


Figure 5. Illumination Response to Various Light Sources

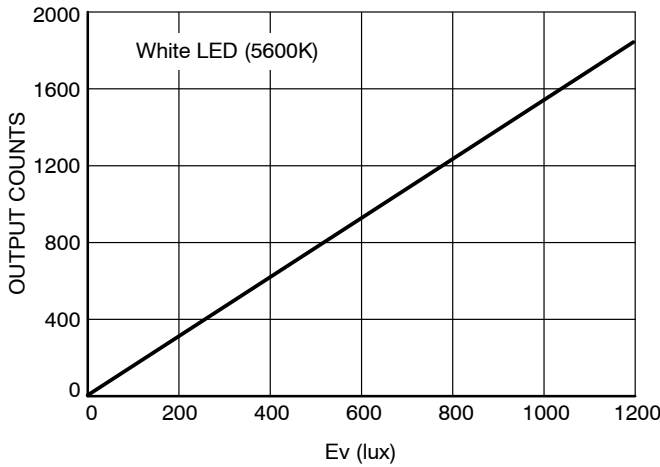


Figure 6. Output Counts vs. Ev

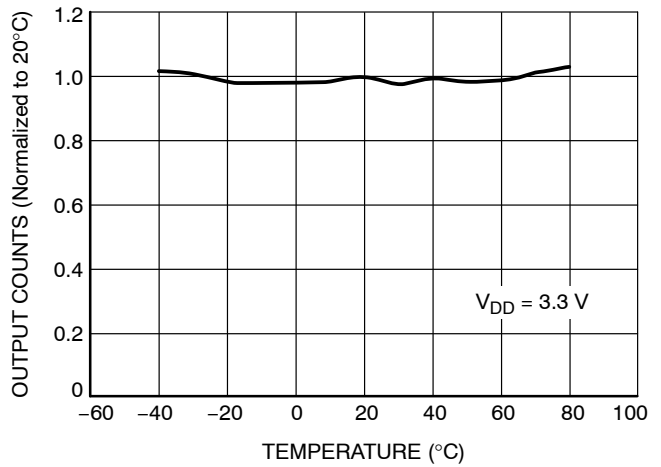


Figure 7. Output Counts vs. Temperature (100 lux)

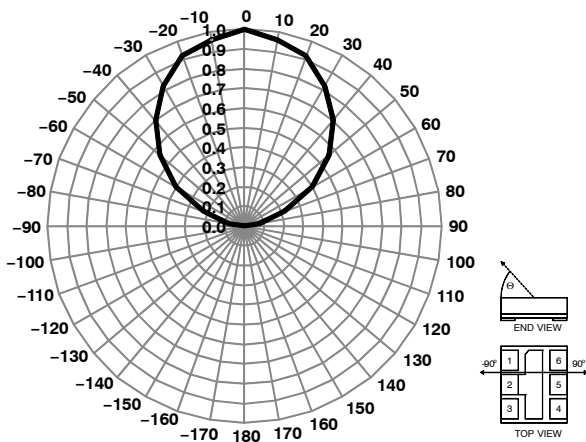


Figure 8. Output Counts vs. Angle (End View, Normalized)

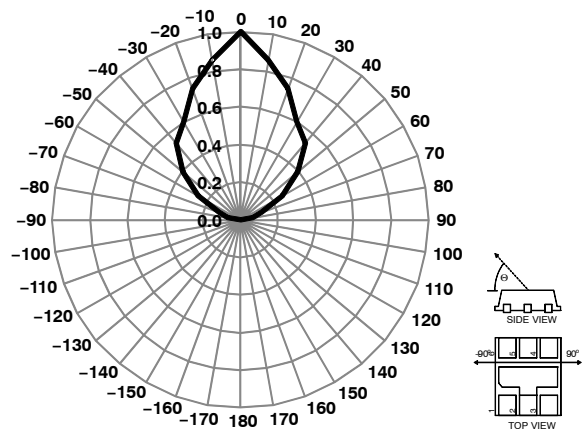


Figure 9. Output Counts vs. Angle (Side View, Normalized)

TYPICAL CHARACTERISTICS

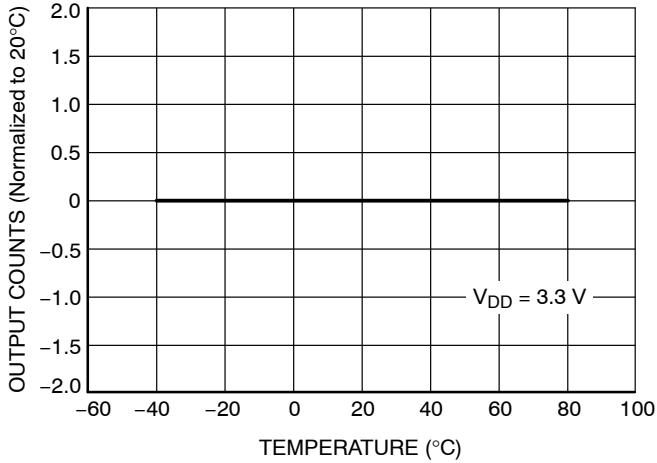


Figure 10. Output Counts vs. Temperature (0 lux)

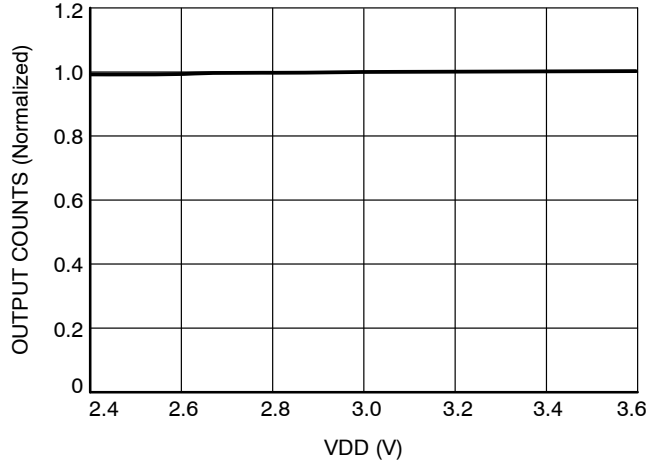


Figure 11. Output Counts vs. Supply Voltage (100 lux)

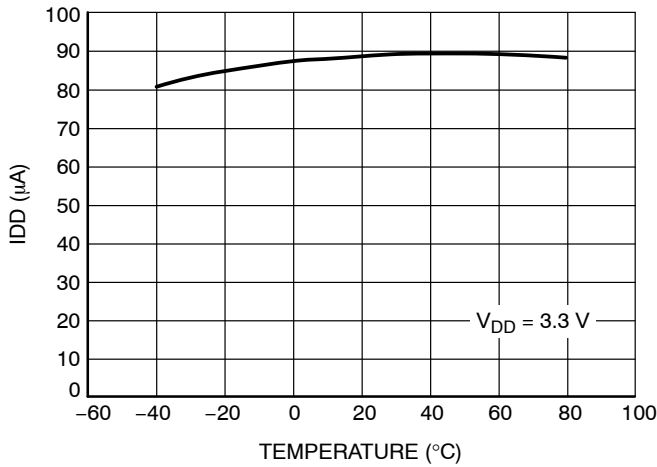


Figure 12. Supply Current vs. Temperature (100 lux)

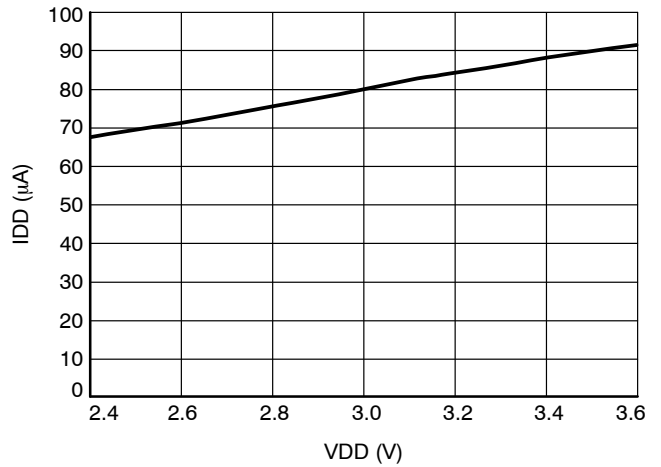


Figure 13. Supply Current vs. Supply Voltage (100 lux)

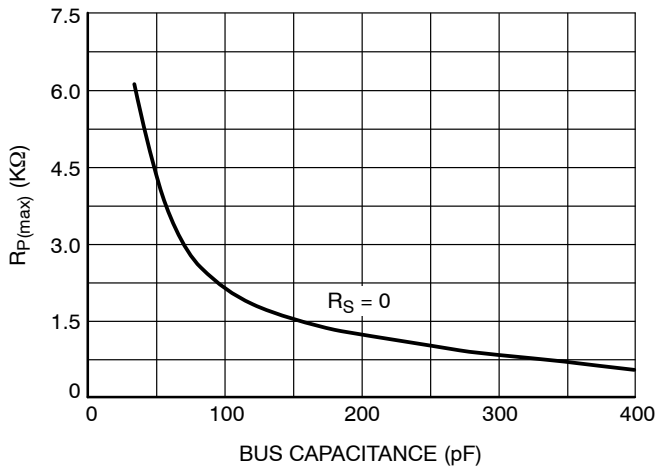


Figure 14. Maximum Value of RP (in kΩ) as a function of Bus Capacitance (in pF)

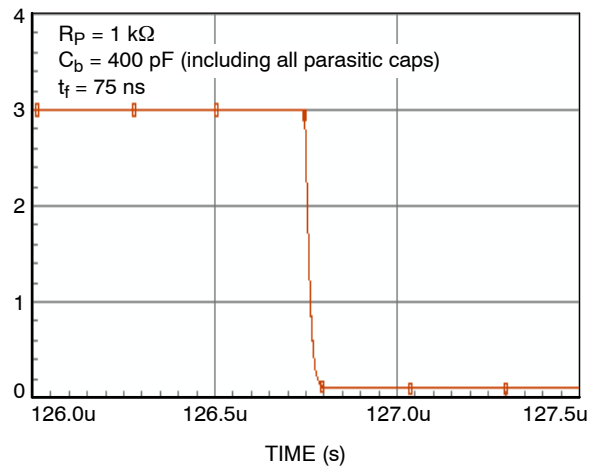


Figure 15. SDA Fall Time (t_f)

DESCRIPTION OF OPERATION

Ambient Light Sensor Architecture

The NOA1305 employs a sensitive photo diode fabricated in ON Semiconductor's standard CMOS process technology. The major components of this sensor are as shown in Figure 2. The photons which are to be detected pass through an ON Semiconductor proprietary color filter limiting extraneous photons and thus performing as a band pass filter on the incident wave front. The filter only transmits photons in the visible spectrum which are primarily detected by the human eye. The photo response of this sensor is as shown in Figure 5.

The ambient light signal detected by the photo diode is converted to digital signal using a variable slope integrating ADC with a resolution of 16-bits, unsigned. The ADC value is provided to the control block connected to the I²C interface block.

Equation 1 shows the relationship of output counts C_{nt} as a function of integration constant I_k , integration time T_{int} (in seconds) and the intensity of the ambient light, I_L (in lux), at room temperature (25°C).

$$I_L = C_{nt} / (I_k \times T_{int}) \quad (\text{eq. 1})$$

Where:

$$I_k \approx 7.7 \text{ (for White LED Source)}$$

For example let:

$$C_{nt} = 1000$$

$$T_{int} = 200 \text{ mS}$$

Intensity of ambient light, I_L (in lux):

$$I_L = 1000 / (7.7 \times 200 \text{ mS}) \quad (\text{eq. 2})$$

$$I_L = 649 \text{ lux}$$

Modes of Operation

The NOA1305 can be placed in any of the following modes of operation by programming registers over the I²C bus:

1. Interrupt driven mode
2. Polling mode
3. Power-down mode

In the interrupt driven mode, once the NOA1305 is configured, no I²C activity is necessary until the ambient light intensity goes above the value programmed in the interrupt threshold register. When this occurs, the device signals an interrupt on the INT pin. Then it is up to the I²C master host to read the ALS count from the device.

In polling mode, interrupts are typically disabled, but the NOA1305 continuously takes measurements and the I²C master host reads out the most recent count whenever it desires to do so, typically in a timed repeat loop.

In power-down mode, the NOA1305 stops taking ambient light measurements and powers down most of the internal circuitry and the INT pin is deactivated. Power is maintained to preserve the register values (static memory) and a portion of the I²C remains active to monitor for a power-on command to the NOA1305.

I²C Interface

The NOA1305 acts as an I²C slave device and supports single register read and write operations, in addition to block read and block write operations. All data transactions on the bus are 8 bits long. Each data byte transmitted is followed by an acknowledge bit. Data is transmitted with the MSB first.

Figure 16 shows an I²C write operation. Write transactions begin with the master sending an I²C start sequence followed by the seven bit slave address (NOA1305 = 0x39) and the write(0) command bit. The NOA1305 will acknowledge this byte transfer with an appropriate ACK. Next the master will send the 8 bit register address to be written to. Again the NOA1305 will acknowledge reception with an ACK. Finally, the master will begin sending 8 bit data segment(s) to be written to the NOA1305 register bank. The NOA1305 will send an ACK after each byte and increment the address pointer by one in preparation for the next transfer. Write transactions are terminated with either an I²C STOP or with another I²C START (repeated START).

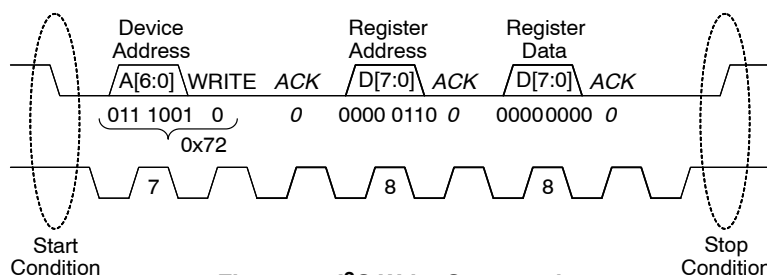


Figure 16. I²C Write Command

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Figure 17 shows the most basic I²C read command sequence sent by the master to the slave device. The sequence consists of a complete I²C write command which sets the address pointer in preparation for the I²C read command since the read command itself does not include a

register address. When reading from a read only data register in the NOA1305 it is acceptable to write a 0 to the register in order to update the address pointer, but the 0 does not actually over-write the value in the data register.

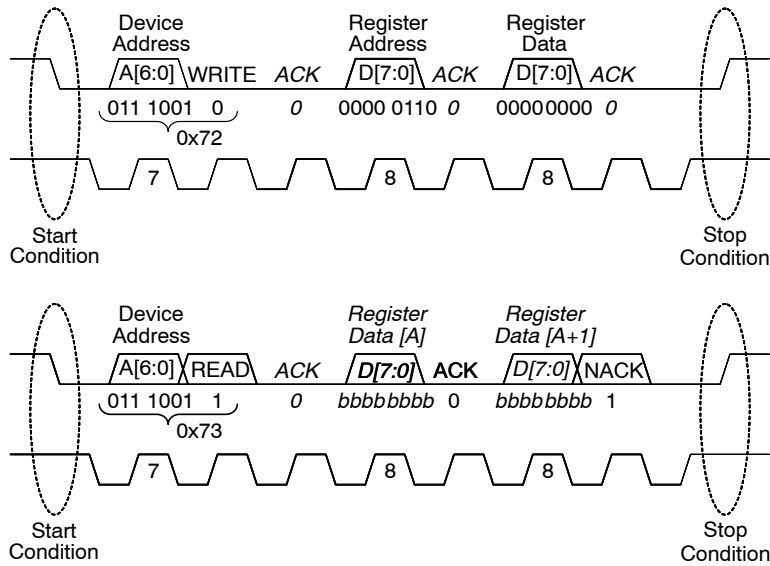


Figure 17. I²C Read Command

Once the I²C write command is completed, the master sends an I²C start sequence followed by the seven bit slave address (NOA1305 = 0x39) and the read (1) command bit. The NOA1305 will acknowledge this byte transfer with an appropriate ACK. The NOA1305 will then begin shifting out data from the register just addressed. If the master wishes to receive more data (next register address), it will ACK the slave at the end of the 8 bit data transmission, and the slave will respond by sending the next byte, and so on. To signal the end of the read transaction, the master will send a NACK bit at the end of a transmission followed by an I²C STOP.

Rise and Fall Time of SDA (Output)

Proper operation of the I²C bus depends on keeping the bus capacitance low and selecting suitable pull-up resistor values. Figure 15 shows the fall time on SDA in output mode under maximum load conditions. The measurement set-up is shown in Figure 18. Figure 14 shows the maximum value of the pull-up resistor (R_P) as a function of the I²C data bus capacitance.

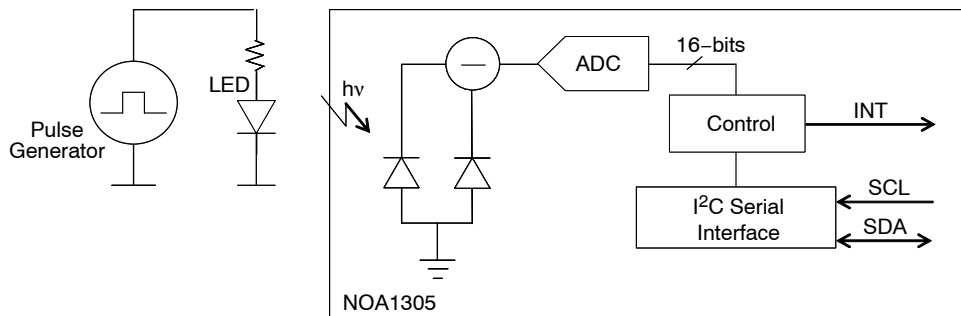


Figure 18. Measurement Set-up

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NOA1305 Data Registers

NOA1305 operation is observed and controlled by internal data registers read from and written to via the external I²C interface. Registers are listed in Table 6. Default values are set on initial power up.

Table 6. NOA1305 DATA REGISTERS (Note 7)

Address	Register	Type	Value (binary)	Description	Default (binary)
0x00	POWER_CONTROL	RW	0000 0000	Power Down	0000 1000
			0000 1000	Power On	
			0000 1001	Test Mode 1 (reserved)	
			0000 1010	Test Mode 2 (fixed output 0x5555)	
			0000 1011	Test Mode 3 (fixed output 0xAAAA)	
0x01	RESET	RW	0001 0000	Reset ALS data. Resets to 0000	0000 0000
0x02	INTEGRATION_TIME	RW	0000 0000	800 ms continuous measurement	0000 0010
			0000 0001	400 ms continuous measurement	
			0000 0010	200 ms continuous measurement	
			0000 0011	100 ms continuous measurement	
			0000 0100	50 ms continuous measurement	
			0000 0101	25 ms continuous measurement	
			0000 0110	12.5 ms continuous measurement	
			0000 0111	6.25 ms continuous measurement	
0x03	INT_SELECT	RW	0000 0001	L → H	0000 0011
			0000 0010	H → L	
			0000 0011	Inactive, always H	
0x04	INT_THRESH_LSB	RW	XXXX XXXX	Interrupt threshold, least significant bits	0000 0000
0x05	INT_THRESH_MSB	RW	XXXX XXXX	Interrupt threshold, most significant bits	0000 1000
0x06	ALS_DATA_LSB	R	XXXX XXXX	ALS measurement data, least significant bits	0000 0000
0x07	ALS_DATA_MSB	R	XXXX XXXX	ALS measurement data, most significant bits	0000 0000
0x08	DEVICE_ID_LSB	R	0001 1001	Device ID value, least significant bits (1305 decimal, 0x0519 hex)	0001 1001
0x09	DEVICE_ID_MSB	R	0000 0101	Device ID value, most significant bits (1305 decimal, 0x0519 hex)	0000 0101

7. Writing a value other than those specified for registers 0x00, 0x01, 0x02, 0x03 will cause the specified default value to be written instead.

POWER_CONTROL Register (0x00)

The POWER_CONTROL register is used to power the device up and down via software control. By default this device powers up in the power ON mode. To reduce power consumption, the NOA1305 can be powered down at any time by writing 0x00 to this register.

To power up the device, use the following write command sequence:

1. Issue Start command
2. Issue 0x72 (lower seven bits of I²C slave address 0x39 followed by write-bit 0)
3. Issue 0x00 for the POWER_CONTROL register address
4. Issue 0x08 to put the device in the power on state
5. Issue Stop command

After applying power to the device or after issuing a power-on command, stable ALS_DATA and INT signal may not be available for the first three integration times. For example with a default of 200 ms integration time, the I²C master should wait at least 600 ms before accessing this device.

To power down the device, use the following write command sequence:

1. Issue Start command
2. Issue 0x72 (lower seven bits of I²C slave address 0x39 followed by write-bit 0)
3. Issue 0x00 for the POWER_CONTROL register address
4. Issue 0x00 to put the device in the power down state
5. Issue Stop command

After issuing a power-on command, the I²C master should wait at least 1.5 ms before accessing this device.

The data registers are set to their default values when power is first applied to the device. However the power-down and power-on commands do not affect the values of the data registers.

The test modes provide a useful debugging mode as they cause the device to output known values in place of the ALS_DATA values.

RESET Register (0x01)

Software reset is controlled by this register. Setting this register followed by an I²C_STOP sequence will immediately reset the NOA1305 to the startup standby state and clear the ALS_DATA register. However the values of the other data registers are not affected.

To reset the device, use the following write command sequence:

1. Issue Start command
2. Issue 0x72 (lower seven bits of I²C slave address 0x39 followed by write-bit 0)
3. Issue 0x01 for the RESET register address
4. Issue 0x10 to reset the device
5. Issue Stop command

After issuing a reset command, the device will reset the RESET register to 0x00.

INTEGRATION_TIME Register (0x02)

The INTEGRATION_TIME register controls the integration time of the ambient light sensor which directly affects the sensitivity.

To set the integration time, use the following write command sequence:

1. Issue Start command
2. Issue 0x72 (lower seven bits of I²C slave address 0x39 followed by write-bit 0)
3. Issue 0x02 for the INTEGRATION_TIME register address
4. Issue 0x02 to set the integration time to 200 ms (for example)
5. Issue Stop command

INT_SELECT Register (0x03)

The INT_SELECT register controls the polarity of the interrupt pin INT and enables or disables interrupts on that pin.

To specify low to high transitions on INT to signal an interrupt, use the following write command sequence:

1. Issue Start command
2. Issue 0x72 (lower seven bits of I²C slave address 0x39 followed by write-bit 0)
3. Issue 0x03 for the INT_SELECT register address
4. Issue 0x01 to specify low to high signaling on INT
5. Issue Stop command

To specify high to low transitions on INT to signal an interrupt, use the following write command sequence:

1. Issue Start command
2. Issue 0x72 (lower seven bits of I²C slave address 0x39 followed by write-bit 0)
3. Issue 0x03 for the INT_SELECT register address
4. Issue 0x02 to specify high to low signaling on INT
5. Issue Stop command

Disabling interrupts causes the INT pin to be held in the open-drain or high state. To disable interrupts completely on the INT pin, use the following write command sequence:

1. Issue Start command
2. Issue 0x72 (lower seven bits of I²C slave address 0x39 followed by write-bit 0)
3. Issue 0x03 for the INT_SELECT register address
4. Issue 0x03 to disable interrupts on INT
5. Issue Stop command

INT_THRESH_LSB and INT_THRES_MSB Registers (0x04, 0x05)

The INT_THRESH register specifies an ambient light threshold value for signaling interrupts on the INT pin. The INT_THRESH register is 16-bits wide to match the 16-bit ALS_DATA register and is accessed over the I²C bus as two 8-bit registers for the least and most significant bits (LSB and MSB). On any measurement cycle where the ALS_DATA intensity count exceeds the INT_THRESH value, the INT pin will become active and will remain active until a measurement cycle where the count is less than or

equal to the threshold (and provided the INT pin is enabled, see INT_SELECT register).

Changing the INT_THRESH register value can cause the INT pin to change immediately if the ALS_DATA to INT_THRESH comparison changes.

Powering down the device will cause the INT pin to become inactive.

To program a value into the INT_THRESH register, use the following write command sequence:

1. Issue Start command
2. Issue 0x72 (lower seven bits of I²C slave address 0x39 followed by write-bit 0)
3. Issue 0x04 for the INT_THRES_LSB register address
4. Issue the 8-bit LSB value
5. Issue Stop command
6. Issue Start command
7. Issue 0x72 (lower seven bits of I²C slave address 0x39 followed by write-bit 0)
8. Issue 0x05 for the INT_THRES_MSB register address
9. Issue the 8-bit MSB value
10. Issue Stop command

After a power-down and power-on sequence, wait at least three integration times for the data to stabilize, before accessing any ALS_DATA values from NOA1305.

ALS_DATA_LSB and ALS_DATA_MSB Registers (0x06, 0x07)

The ALS_DATA register holds the ambient light intensity count from the most recent measurement. The ALS_DATA register is 16-bits wide and is accessed from the I²C bus as two 8-bit registers for the least and most significant bits (LSB and MSB).

To read the ALS_DATA register, use the following read command sequence:

1. Issue Start command
2. Issue 0x72 (lower seven bits of I²C slave address 0x39 followed by write-bit 0)
3. Issue 0x06 for the INT_DATA_LSB register address
4. Issue Start command
5. Issue 0x73 (lower seven bits of I²C slave address 0x39 followed by read-bit 1)
6. Read the ALS_DATA_LSB byte
7. Read the ALS_DATA_MSB byte
8. Issue Stop command

DEVICE_ID_LSB and DEVICE_ID_MSB Registers (0x08, 0x09)

The DEVICE_ID register is a pre-programmed register that describes the device. For the NOA1305, the register holds the decimal value of 1305 (0x0519). The DEVICE_ID register is 16-bits wide and is accessed from the I²C bus as two 8-bit registers for the least and most significant bits (LSB and MSB).

To read the DEVICE_ID register, use the following read command sequence:

1. Issue Start command
2. Issue 0x72 (lower seven bits of I²C slave address 0x39 followed by write-bit 0)
3. Issue 0x08 for the DEVICE_ID_LSB register address
4. Issue Start command
5. Issue 0x73 (lower seven bits of I²C slave address 0x39 followed by read-bit 1)
6. Read the DEVICE_ID_LSB byte
7. Read the DEVICE_ID_MSB byte
8. Issue Stop command

NOA1305

Example Programming Sequence

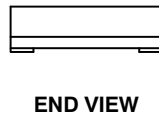
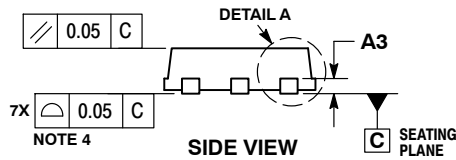
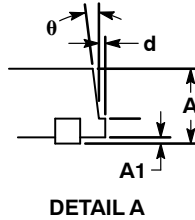
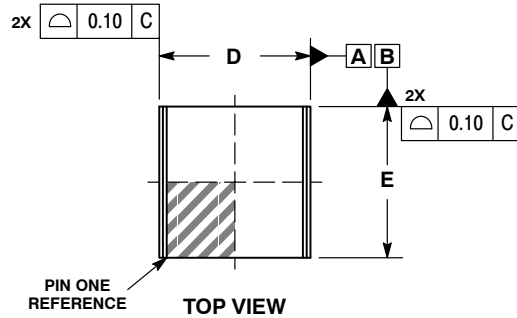
The following pseudo code configures the NOA1305 ambient light sensor and then runs it in an interrupt driven mode. When the controller receives an interrupt, it reads the ALS_Data from the device, sets a flag and then waits for the main polling loop to respond to the ambient light change.

```
external subroutine I2C_Read_Byte (I2C_Address, Data_Address);
external subroutine I2C_Read_Block (I2C_Address, Data_Start_Address, Count, Memory_Map);
external subroutine I2C_Write_Byte (I2C_Address, Data_Address, Data);
external subroutine I2C_Write_Block (I2C_Address, Data_Start_Address, Count, Memory_Map);
subroutine Initialize_ALS () {
  MemBuf[0x00] = 0x08; // POWER_CONTROL assert Power On
  MemBuf[0x01] = 0x10; // RESET assert reset
  MemBuf[0x02] = 0x02; // INTEGRATION_TIME select 200ms
  MemBuf[0x03] = 0x01; // INT_SELECT select Low to High
  MemBuf[0x04] = 0xFF; // INT_THRESH_LSB
  MemBuf[0x05] = 0x8F; // INT_THRESH_MSB
  I2C_Write_Block (I2CAddr, 0x00, 6, MemBuf);
}
subroutine I2C_Interupt_Handler () {
  // Retrieve and store the ALS data
  ALS_Data_LSB = I2C_Read_Byte (I2CAddr, 0x06);
  ALS_Data_MSB = I2C_Read_Byte (I2CAddr, 0x07);
  NewALS = 0x01;
}
subroutine main_loop () {
  I2CAddr = 0x39;
  NewALS = 0x00;
  Initialize_ALS ();
  loop {
    // Do some other polling operations
    if (NewALS == 0x01) {
      NewALS = 0x00;
      // Do some operations with ALS_Data
    }
  }
}
```

NOA1305

PACKAGE DIMENSIONS

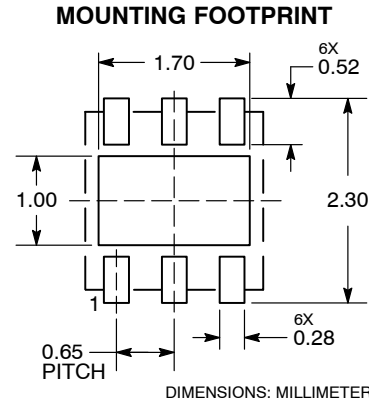
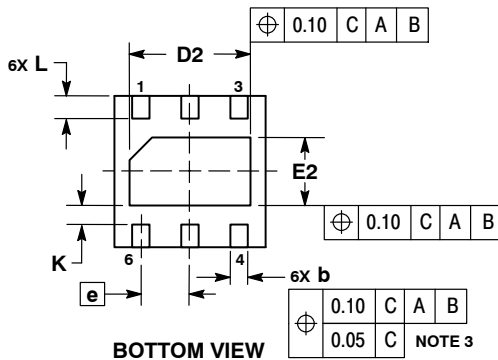
CUDFN6, 2x2
CASE 505AD-01
ISSUE B



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30mm FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

DIM	MILLIMETERS	
	MIN	MAX
A	0.55	0.65
A1	0.00	0.05
A3	0.20 REF	
b	0.18	0.28
D	2.00 BSC	
D2	1.50	1.70
d	---	0.10
E	2.00 BSC	
E2	0.80	1.00
e	0.65 BSC	
K	0.20	---
L	0.25	0.35
theta	4°	10°



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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